SM802108



ClockWorks™ 10GbE & GbE (156.25MHz, 125MHz) Ultra-Low Jitter, LVPECL Frequency Synthesizer

General Description

The SM802108 is a member of the ClockWorks™ family of devices from Micrel and provides an extremely low-noise timing solution for GbE and 10GbE Ethernet clock signals. It is based upon a unique patented RotaryWave® architecture that provides very low phase noise.

The device operates from a 3.3V or 2.5V power supply and synthesizes two LVPECL output clocks at 156.25MHz and another two at 125MHz. The SM802108 accepts a 25 MHz crystal or LVCMOS reference clock.

Data sheets and support documentation can be found on Micrel's web site at: www.micrel.com.

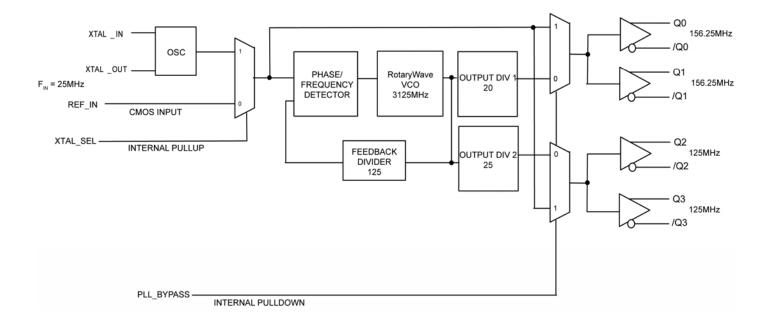
Features

- Generates two LVPECL clock outputs at 156.25MHz and two LVPECL clock outputs at 125MHz
- 2.5V or 3.3V operating range
- Typical phase jitter @ 156.25MHz (1.875MHz to 20MHz): 110fs (typical) at 3.3V
- Industrial temperature range
- Green, RoHS, and PFOS compliant
- Available in 24-pin 4mm × 4mm QFN package

Applications

- 10Gigabit Ethernet
- Gigabit Ethernet

Block Diagram



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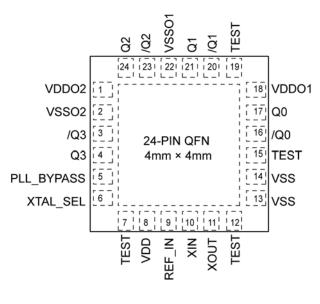
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Ordering Information

Part Number	Marking	Shipping	Junction Temperature Range	Package
SM802108UMG	802108	Tube	–40°C to +85°C	24-Pin QFN
SM802108UMGR	802108	Tape and Reel	–40°C to +85°C	24-Pin QFN

Note:

Pin Configuration



24-Pin QFN (Top View)

Pin Description

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
16, 17	/Q0, Q0	O (DIE)	LVPECL	Differential Clock Outputs from Bank 1
20, 21	/Q1, Q1	O, (DIF)	LVPECL	156.25MHz
23, 24	/Q2, Q2	O (DIE)	LVPECL	Differential Clock Outputs from Bank 2
3, 4	/Q3, Q3	O, (DIF)	LVPECL	125MHz
1	VDDO2	PWR		Power Supply for Output Bank 2
2	VSSO2	PWR		Power Supply Ground for Output Bank 2
				PLL Bypass, Selects Output Source
5	PLL BYPASS	1 (05)	LVCMOS	0 = Normal PLL Operation
5	FLL_BTFASS	I, (SE)	LVCIVIOS	1 = Output from Input Reference Clock or Crystal
				45KΩ pull-down
6	0		LVCMOS	Selects PLL Input Reference Source
6 XTAL_SEL		I, (SE)	LVCIVIOS	0 = REF_IN, 1 = XTAL, 45KΩ pull-up

^{1.} Devices are Green, RoHS, and PFOS compliant.

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Pin Description (Continued)

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function	
7, 12, 15, 19	TEST			Factory Test Pins, Do not connect anything to these pins.	
8	VDD	PWR		Core Power Supply	
9	REF_IN	I, (SE)	LVCMOS	Reference Clock Input	
10	XIN	L (CE)	12pF on otal	Crystal Reference Input, no load caps needed.	
10	AIIN	I, (SE)	12pF crystal	See Fig. 5.	
11	XOUT	0 (85)	12pF on otal	Crystal Reference Output, no load caps needed.	
11	7001	O, (SE)	12pF crystal	See Fig. 5.	
13, 14	VSS	PWR		Core Power Supply Ground	
18	VDDO1	PWR		Power Supply for Output Bank 1	
22	VSSO1	PWR		Power Supply Ground for Output Bank 1	

Application Information

Input Reference

When operating with a crystal input reference, do not apply a switching signal to REF_IN.

Crystal Layout

Keep the layers under the crystal as open as possible. Do not place switching signals or noisy supplies under the crystal.

Truth Table

PLL_BYPASS	XTAL_SEL	INPUT	OUTPUT
0	_	_	PLL
1	_	-	XTAL/REF_IN
-	0	REF_IN	_
_	1	XTAL	_

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Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V _{DD} , V _{DDOx})	+4.6V
Input Voltage (V _{IN})	
Lead Temperature (soldering	g, 20sec.)260°C
Case Temperature	115°C
Storage Temperature (T _s)	65°C to +150°C

Operating Ratings⁽²⁾

Supply Voltage (V _{DD} , V _{DDOx})	+2.375V to +3.465V
Ambient Temperature (T _A)	40°C to +85°C
Junction Thermal Resistance ⁽³⁾	
QFN (θ_{JA})	
Still-Air	50°C/W
QFN (Ψ _{JB})	
Junction-to-Board	30°C/W

DC Electrical Characteristics⁽⁴⁾

 $V_{DD} = V_{DDO1/2} = 3.3V \pm 5\%$ or $2.5V \pm 5\%$

 V_{DD} = 3.3V ±5%, $V_{DDO1/2}$ = 3.3V ±5% or 2.5V ±5%

 $T_A = -40^{\circ}C \text{ to } +85^{\circ}C.$

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V_{DD}, V_{DDOx}	2.5V Operating Voltage		2.375	2.5	2.625	V
V_{DD},V_{DDOx}	3.3V Operating Voltage		3.135	3.3	3.465	V
I _{DD}	Supply current V _{DD} + V _{DDO}	Outputs open; REF_IN source, XTAL_SEL = 0		130	165	mA
I _{DD}	Supply current V _{DD} + V _{DDO}	Outputs open; CRYSTAL source, XTAL_SEL = 1		145	185	mA

LVPECL DC Electrical Characteristics (4)

 $V_{DD} = V_{DDO1/2} = 3.3V \pm 5\%$ or $2.5V \pm 5\%$

 V_{DD} = 3.3V ±5%, $V_{DDO1/2}$ = 3.3V ±5% or 2.5V ±5%

 T_A = $-40^{\circ}C$ to $+85^{\circ}C$. R_L = 50Ω to $V_{DDO}-2V$

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V _{OH}	Output High Voltage		V _{DDO} – 1.145	V _{DDO} – 0.97	V _{DDO} – 0.845	V
V _{OL}	Output Low Voltage		V _{DDO} – 1.945	V _{DDO} – 1.77	V _{DDO} – 1.645	V
V _{SWING}	Output Voltage Swing		0.6	0.8	1.0	V

Note:

- Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
- Package thermal resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB.
- The circuit is designed to meet the AC and DC specifications shown in the above table(s) after thermal equilibrium has been established.

LVCMOS (PLL_BYPASS, XTAL_SEL) DC Electrical Characteristics⁽⁴⁾

 V_{DD} = 3.3V ±5%, or 2.5V ±5%, T_A = -40°C to +85°C.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V _{IH}	Input High Voltage		2		V _{DD} + 0.3	V
V _{IN}	Input Low Voltage		-0.3		0.8	V
I _{IH}	Input High Current	V _{DD} = V _{IN} = 3.465V			150	μΑ
I _{IL}	Input Low Current	V _{DD} = 3.465V, V _{IN} = 0V	-5			μΑ

REF_IN DC Electrical Characteristics(4)

 V_{DD} = 3.3V ±5%, or 2.5V ±5%, T_A = $-40^{\circ}C$ to +85°C.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V _{IH}	Input High Voltage		1.1		V _{DD} + 0.3	V
V_{IL}	Input Low Voltage		-0.3		0.6	V
I _{IN}	Input Current	$XTAL_SEL = V_{IL}, V_{IN} = 0V \text{ to } V_{DD}$	-5		5	μА
I _{IN}	Input Current	XTAL_SEL = V _{IH} , V _{IN} = V _{DD}		20		μA

Crystal Characteristics

NDK NX2520SA

Parameter	Condition	Min.	Тур.	Max.	Units		
Mode of Oscillation	12pF Load	F	Fundamental, Parallel Resonant				
Frequency			25		MHz		
Equivalent Series Resistance (ESR)				50	Ω		
Shunt Capacitor, C0			3	7	pF		
Correlation Drive Level			100	300	uW		

AC Electrical Characteristics(4, 5)

 V_{DD} = $V_{DDO1/2}$ = 3.3V ±5% or 2.5V ±5%

 V_{DD} = 3.3V ±5%, $V_{DDO1/2}$ = 3.3V ±5% or 2.5V ±5%

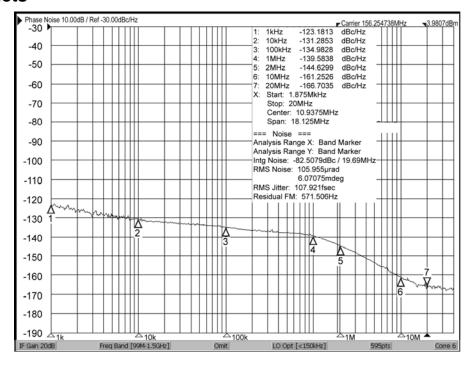
 T_A = $-40^{\circ}C$ to $+85^{\circ}C.$ R_L = 50Ω to $V_{DDO}-2V$

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
F _{OUT1}	Output Frequency 1			156.25		MHz
F _{OUT2}	Output Frequency 2			125		
Ppm	Output ppm Variation	Crystal reference. Note 6	-50		50	ppm
F _{REF}	Reference Input Frequency			25		MHz
T _R /T _F	LVPECL Output Rise/Fall Time	20% – 80%	80	175	350	ps
ODC	Output Duty Cycle		48	50	52	%
T _{SKEW}	Output-to-Output Skew	Within bank. Note 7			45	ps
T _{LOCK}	PLL Lock Time				20	ms
T _{jit} (∅)	RMS Phase Jitter ⁽⁸⁾	156.25MHz Integration Range (1.875MHz – 20MHz) Integration Range (12kHz – 20MHz) 125MHz Integration Range (1.875MHz – 20MHz) Integration Range (12kHz – 20MHz)		110 250 110 250		fs
	Spurious Noise Components	6.25MHz 25MHz		-73 -58		dBc

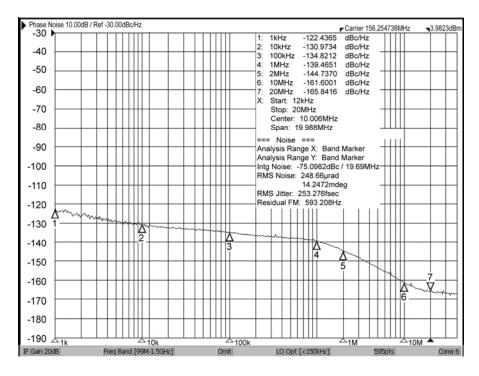
Notes:

- All phase noise measurements were taken with an Agilent 5052B phase noise system.
- Crystal tolerance at room less than +/- 15ppm, over temp less than +/- 20ppm.
- 7. Defined as skew between outputs at the same supply voltage and with equal load conditions and same frequency; Measured at the output differential crossing points.
- Measured using 25MHz crystal as the input reference source. 8.

Phase Noise Plots

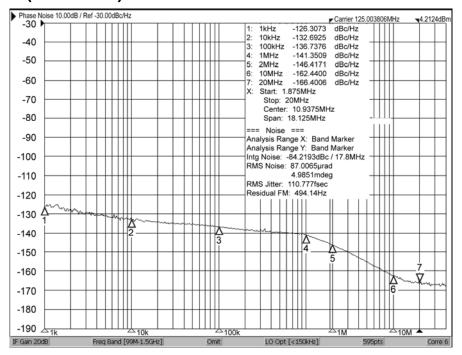


Phase Noise Plot: 156.25MHz, 1.875MHz - 20MHz 108fS

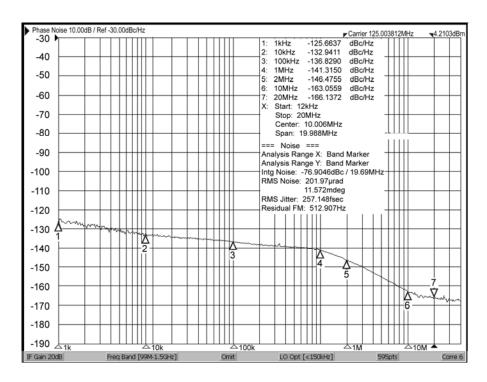


Phase Noise Plot: 156.25MHz, 12kHz - 20MHz 253fS

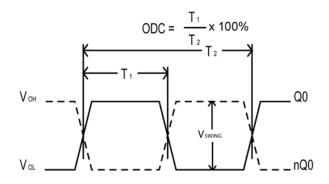
Phase Noise Plots (Continued)



Phase Noise Plot: 125MHz, 1.875MHz - 20MHz 111fS



Phase Noise Plot: 125MHz, 12kHz - 20MHz 257fS



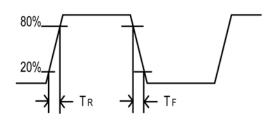


Figure 1. Duty Cycle Tlming

Figure 2. All Outputs Rise/Fall Time

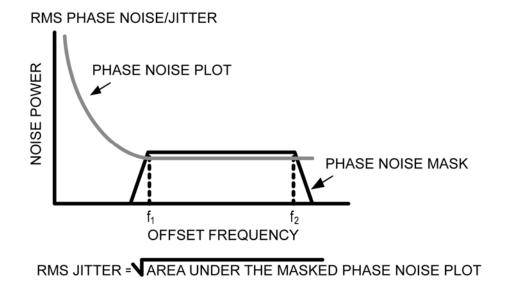


Figure 3. RMS Phase/Noise/Jitter

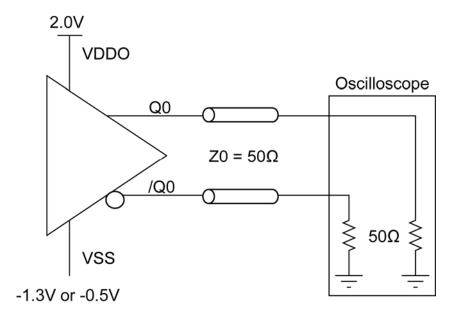


Figure 4. LVPECL Output Load and Test Circuit

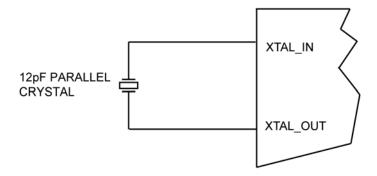
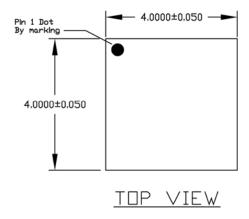
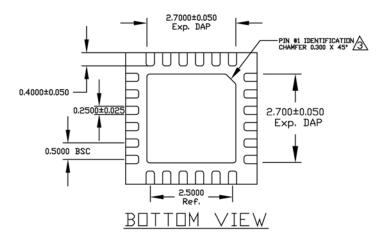
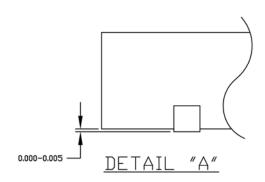


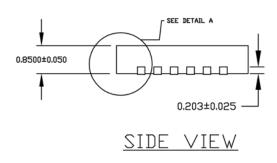
Figure 5. Crystal Input Interface

Package Information









NOTE:

- 1. ALL DIMENSIONS ARE IN MILLIMETERS (mm).
- THE PIN#1 IDENTIFIER MUST EXIST ON THE TOP SURFACE OF PACKAGE BY USING IDENTIFICATION MARK OR OTHER FEATURE OF PACKAGE BODY.

3. CHAMFER STYLE PIN 1 IDENTIFIER ON BOTTOM SIDE

24-Pin QFN

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